



NOTES:

1. ALL DIMENSIONS ARE IN MILLIMETERS UNLESS OTHERWISE SPECIFIED.
2. MATERIAL MUST COMPLY WITH BANNED AND RESTRICTED SUBSTANCES SPEC # 10-0131.
3. THE BASIC SOLDER BALL GRID PITCH IS 1.27 MM.
4. PRIMARY DATUM \square AND SEATING PLANES ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.
5. A1 CORNER MUST BE IDENTIFIED BY LASER MARK ON TOP PACKAGE.
6. ALL DIMENSIONS APPLY TO LEADED (-), LEAD FREE (+) PKG. CODES.
7. PACKAGE CODE: V36-1



TITLE: PACKAGE OUTLINE, 36 BALLS PBGA , W/ CRYSTAL 10.16x11.43x3.16mm, 1.27mm PITCH, 2 LAYER			
APPROVAL	DOCUMENT CONTROL NO. 21-0363	REV. B	1/1